## COMBIN. DECLARATION AND POWER OF. TORNEY

As the below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name and that I believe I am an original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled

## POST-CMP REMOVAL OF SURFACE CONTAMINANTS FROM SILICON WAFER

the specification of wh	nich			
I hereby state specification, including I acknowledge tapplication in accorda	erial No that I have reviewed a g the claims, as amende he duty to disclose info nce with Title 37, Code o	and was amended on and understand the content of by any amendment referrent ormation which is material to federal Regulations, § 1.5 ander Title 35, Untied States Content of the listed below and have also in the content of the listed below and have also in the content of the listed below and have also in the li	ts of the and to above. To the patents  56(a).  Code, § 119	tability of this
application for patent	or inventor's certificate ha	aving a filing date before that	of the applic	cation on which
priority is claimed: Prior Foreign Applicat	ion(s):			
Number	Country	Date Filed(yyyy/mm/dd)	Yes	No
90109738	Taiwan, R.O.C.	2001/4/24	X	
- · · · · · · · · · · · · · · · · · · ·		•	ith: o (Reg. N (Reg. N	lo. 37,436) lo. 43,330) lo. 46,863)
SEND CORRESPONDENCE TO:		DIRECT TELEPHONE CALLS TO: (Name and telephone number)		
CHARLES C.H. WU & ASSOCIATES 7700 IRVINE CENTER DRIVE Suite 710, Irvine, California 92618-3043		Charles C.H. Wu (949) 251-0111		

## COMBINED DE ARATION AND POWER OF ATTO. EY CONTINUED

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patents issued thereon.

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